

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent CdV/dt effect decline
- Green Device Available

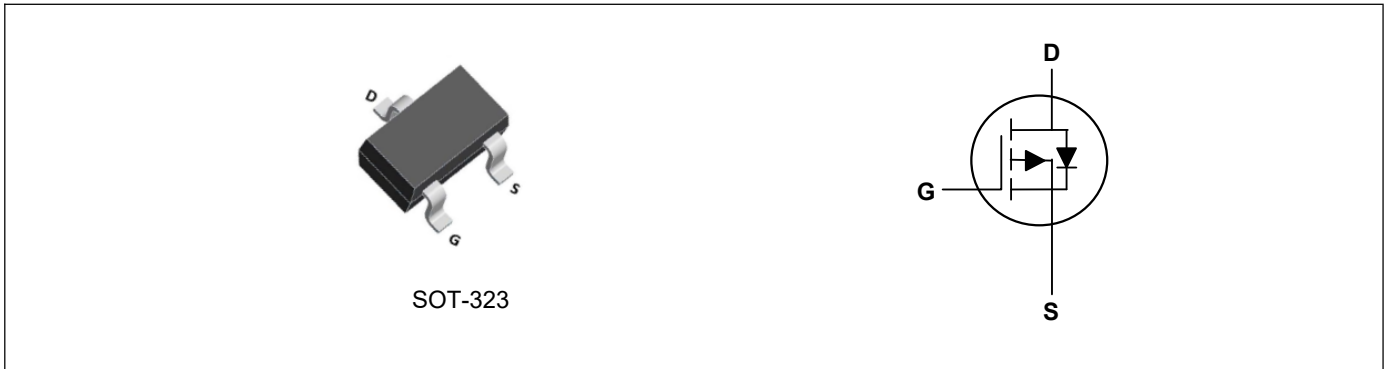
Product Summary



V_{DS}	-20	V
I_D	-2.3	A
$R_{DS(ON)}$ (at $V_{GS}=-4.5V$)	110	m Ω
$R_{DS(ON)}$ (at $V_{GS}=-2.5V$)	140	m Ω

Applications

- High Frequency Point-of-Load, Synchronous Buck Converter
- Networking DC-DC Power System
- Load Switch



Absolute Maximum Ratings($T_A=25^{\circ}C$, unless otherwise noted)

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	-20	V
Gate-Source Voltage	V_{GS}	± 12	V
Continuous Drain Current	I_D	-2.3	A
Pulsed Drain Current ²	I_{DM}	-10	A
Total Power Dissipation	P_D	0.2	W
Storage Temperature Range	T_{STG}	-55 to 150	$^{\circ}C$
Operating Junction Temperature Range	T_J	-55 to 150	$^{\circ}C$

Thermal Characteristics

Parameter	Symbol	Typ	Max	Unit
Thermal Resistance Junction-Ambient ¹	$R_{\theta JA}$	---	625	$^{\circ}C/W$

Electrical Characteristics ($T_J=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-20	---	---	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=-4.5V, I_D=-2.8A$	---	100	110	$m\Omega$
		$V_{GS}=-2.5V, I_D=-2A$	---	120	140	$m\Omega$
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-0.4	-0.7	-1	V
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-20V, V_{GS}=0V, T_J=25^\circ\text{C}$	---	---	-1	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 12V, V_{DS}=0V$	---	---	± 100	nA
Forward Transconductance	g_{fs}	$V_{DS}=-5V, I_D=-2.8A$	---	4	---	S
Total Gate Charge	Q_g	$V_{DS}=-10V, V_{GS}=-2.5V, I_D=-3A$	---	3.3	---	nC
Gate-Source Charge	Q_{gs}		---	0.7	---	
Gate-Drain Charge	Q_{gd}		---	1.3	---	
Turn-On Delay Time	$T_{d(on)}$	$V_{DD}=-10V, I_D=-1A, V_{GS}=-4.5V, R_G=10\Omega$	---	11	---	ns
Rise Time	T_r		---	35	---	
Turn-Off Delay Time	$T_{d(off)}$		---	30	---	
Fall Time	T_f		---	10	---	
Input Capacitance	C_{iss}	$V_{DS}=-10V, V_{GS}=0V, f=1\text{MHz}$	---	405	---	pF
Output Capacitance	C_{oss}		---	75	---	
Reverse Transfer Capacitance	C_{rss}		---	55	---	

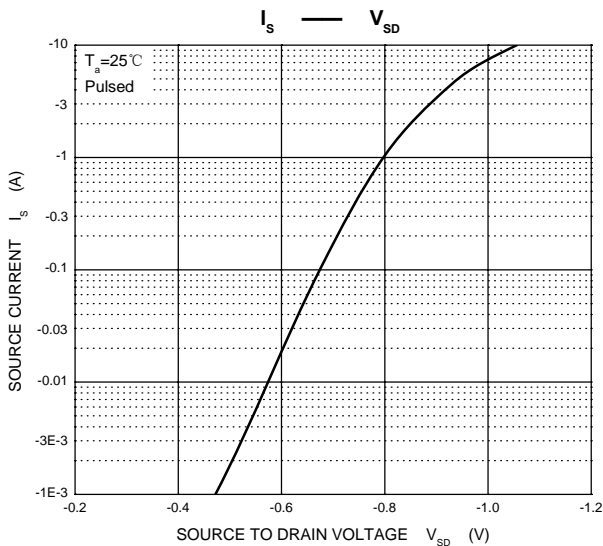
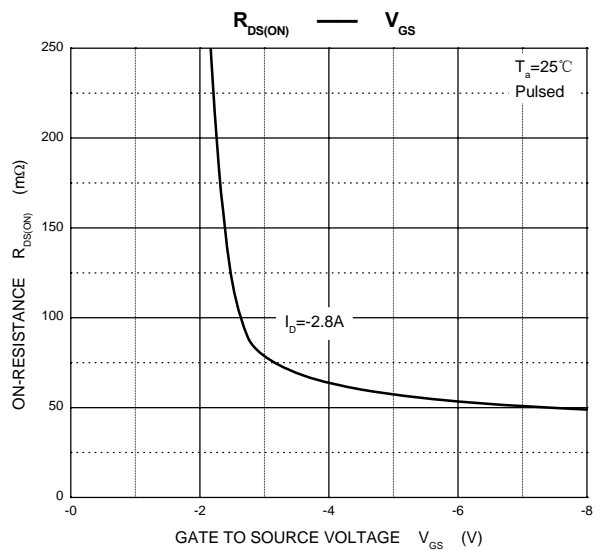
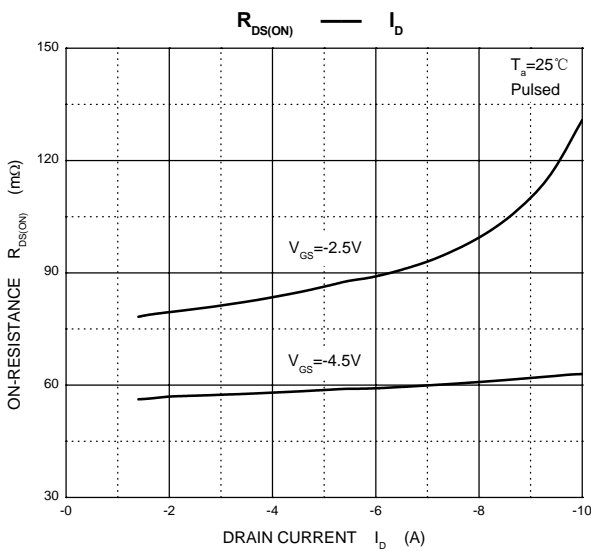
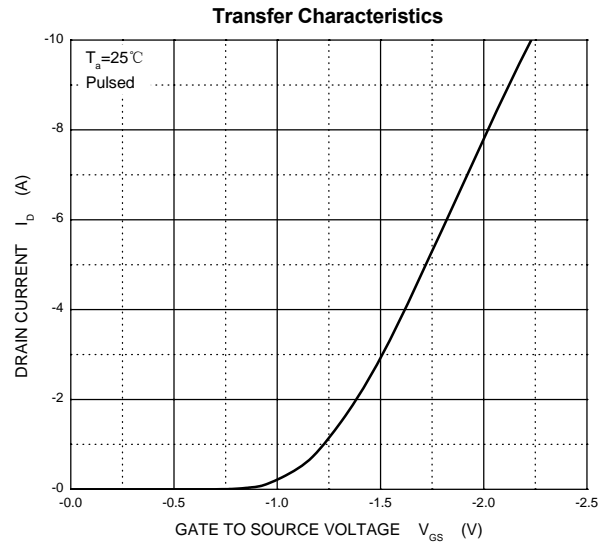
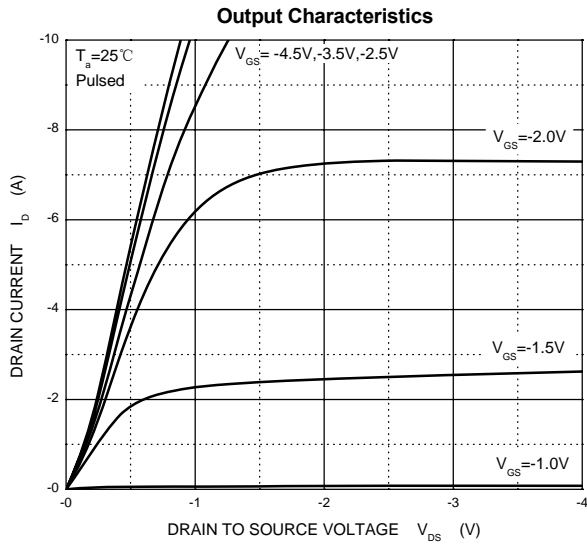
Drain-Source Diode Characteristics

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Continuous Source Current ²	I_S	$V_G=V_D=0V$, Force Current	---	---	-1.3	A
Diode Forward Voltage ¹	V_{SD}	$V_{GS}=0V, I_S=-1.3A, T_J=25^\circ\text{C}$	---	---	-1.2	V

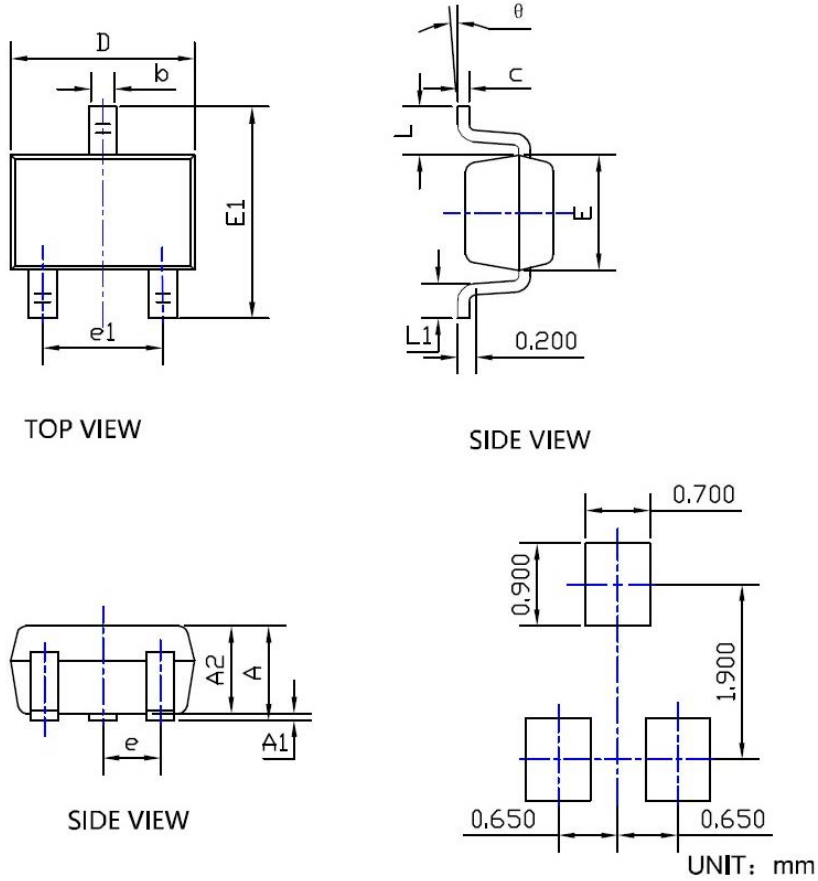
Note:

- 1.The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper.
- 2.The data tested by pulsed , pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$

Typical Characteristics



SOT323 Package Outline Dimensions



Symbol	Dimensions (unit:mm)			Symbol	Dimensions (unit:mm)		
	Min	Typ	Max		Min	Typ	Max
A	0.90	1.00	1.10	E₁	2.15	2.30	2.45
A₁	--	--	0.10	e	--	0.65	--
A₂	0.90	0.95	1.00	e₁	1.20	1.30	1.40
b	0.15	0.30	0.40	L	--	0.525	--
c	0.10	0.17	0.25	L₁	0.26	0.36	0.46
D	1.80	2.00	2.20	θ	0°		8°
E	1.15	1.25	1.35				